

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
20V	25m $\Omega$ @4.5V	4.5A
	32m $\Omega$ @2.5V	
	46m $\Omega$ @1.8V	

## Feature

- Trench Power MV MOSFET technology
- High Power and current handing capability
- Suffix "-Q1" for AEC-Q101

## Application

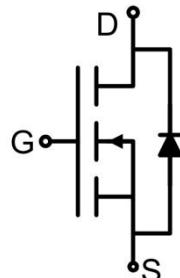
- PWM application
- Load switch

## Package

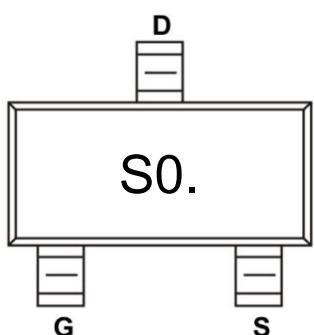


SOT-23

## Circuit diagram



## Marking



**Absolute maximum ratings (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	V
Gate-Source Voltage	V <sub>GS</sub>	±10	V
Continuous Drain Current	I <sub>D</sub>	4.5	A
Continuous Drain Current (T <sub>A</sub> =70°C)	I <sub>D</sub> (70°C)	3.6	A
Pulsed Drain Current <sup>1)</sup>	I <sub>DM</sub>	18	A
Power Dissipation	P <sub>D</sub>	1	W
Thermal Resistance Junction-to-Ambient <sup>2)</sup>	R <sub>θJA</sub>	125	°C/W
Operating Junction Temperature	T <sub>J</sub>	-55 ~ +150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

**Electrical characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	20			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±10V			±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.45	0.62	1	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.5A		19.5	25	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =3A		25	32	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =2.7A		33	46	

**Dynamic characteristics<sup>3)</sup>**

Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f =1MHz		418		pF
Output Capacitance	C <sub>oss</sub>			82		
Reverse Transfer Capacitance	C <sub>rss</sub>			70		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.5A		6.05		nC
Gate-Source Charge	Q <sub>gs</sub>			1.07		
Gate-Drain Charge	Q <sub>gd</sub>			1.95		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =4.5V R <sub>G</sub> =3Ω, R <sub>L</sub> =1Ω		4.2		nS
Turn-on rise time	t <sub>r</sub>			19.8		
Turn-off delay time	t <sub>d(off)</sub>			22.6		
Turn-off fall time	t <sub>f</sub>			23.2		

**Source-Drain Diode characteristics**

Diode Forward Current	I <sub>S</sub>			4.5	A
Diode Forward voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =4.5A		1.2	V
Reverse Recovery Time	T <sub>rr</sub>	I <sub>F</sub> =4.5A, di/dt =100A/us		17.9	nS
Reverse Recovery Charge	Q <sub>rr</sub>			1.38	nC

Notes:

1) Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤2%.

2) R<sub>θJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>θJC</sub> is guaranteed by design, while R<sub>θJA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

3) Guaranteed by design, not subject to production testing.



## Typical Characteristics

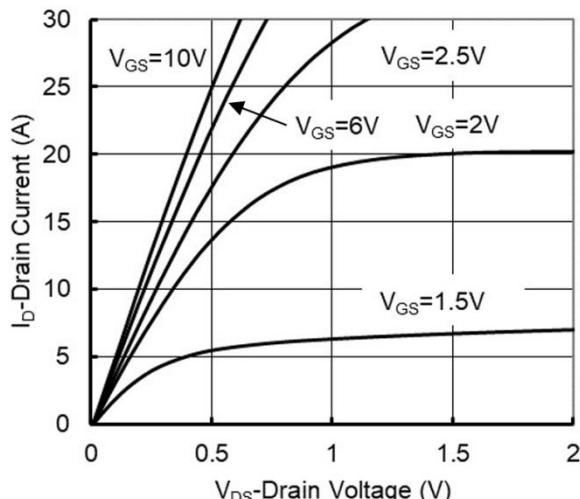


Figure 1. Output Characteristics

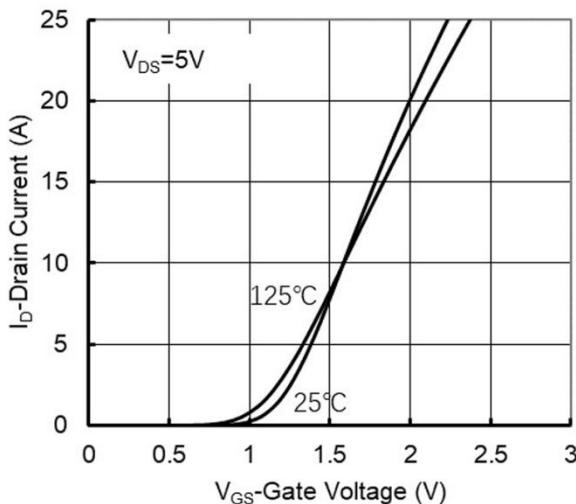


Figure 2. Transfer Characteristics

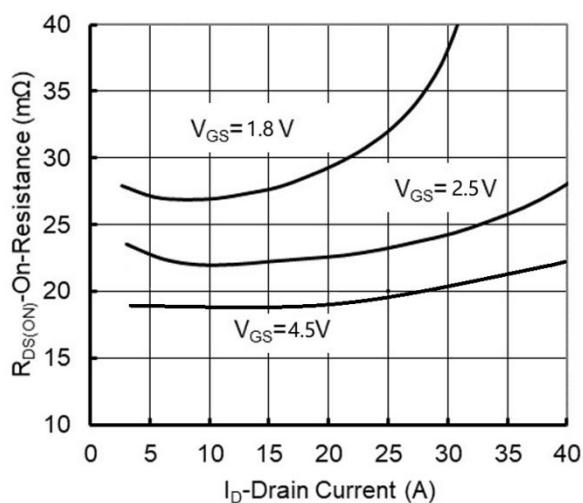


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

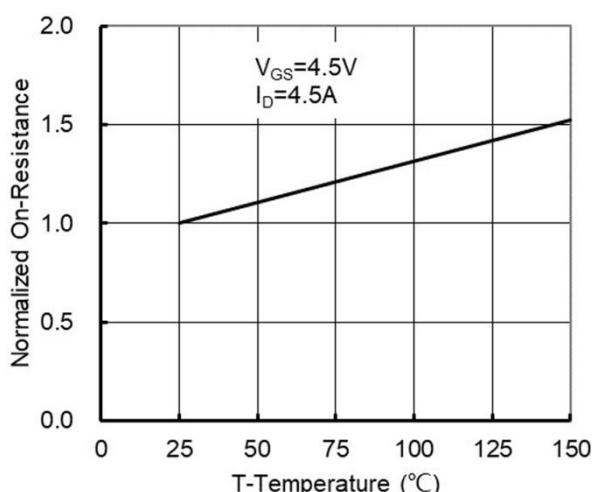


Figure 4: On-Resistance vs. Junction Temperature

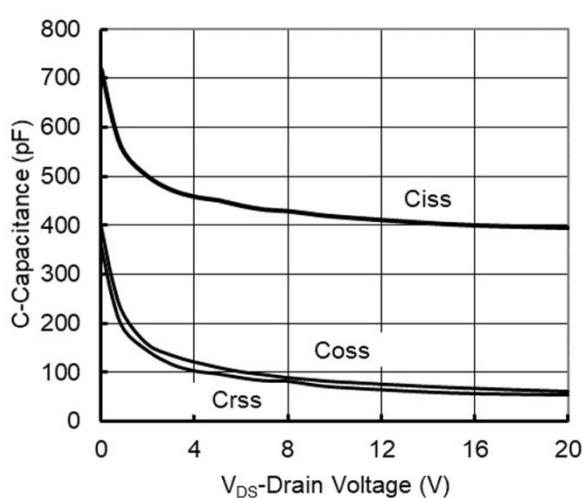


Figure 5. Capacitance Characteristics

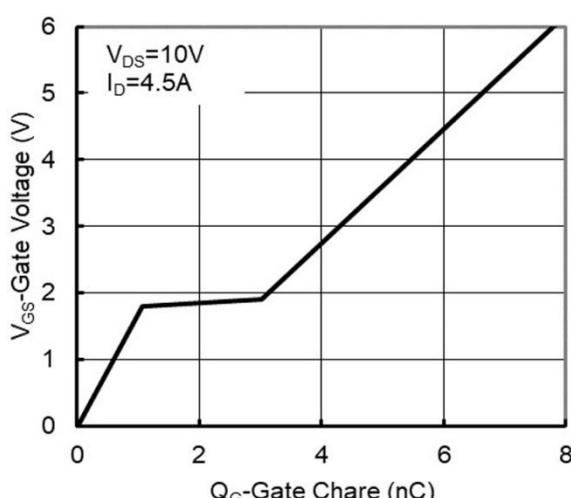


Figure 6. Gate Charge

## Typical Characteristics

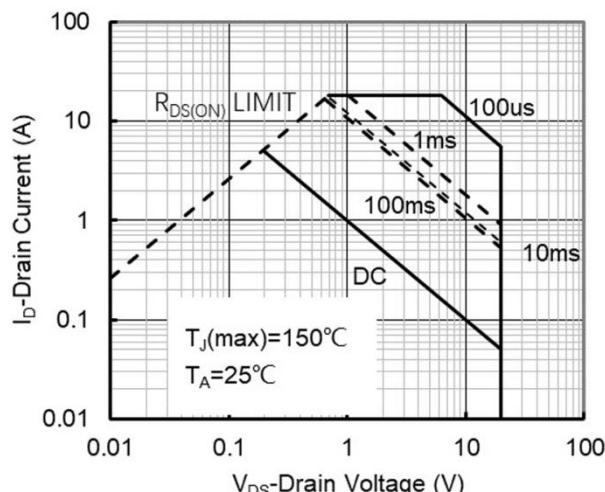


Figure 7. Safe Operation Area

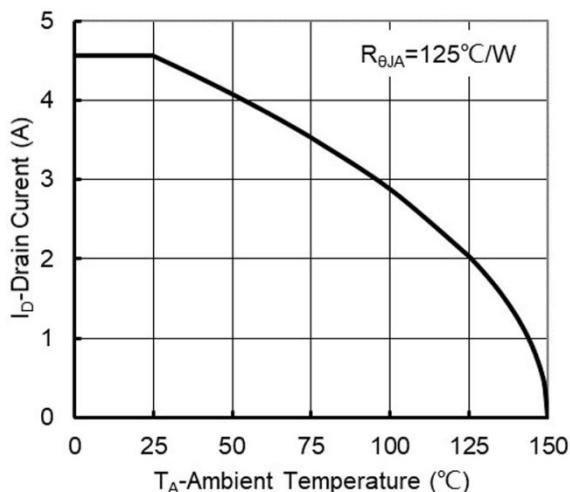


Figure 8. Maximum Continuous Drain Current vs Ambient Temperature

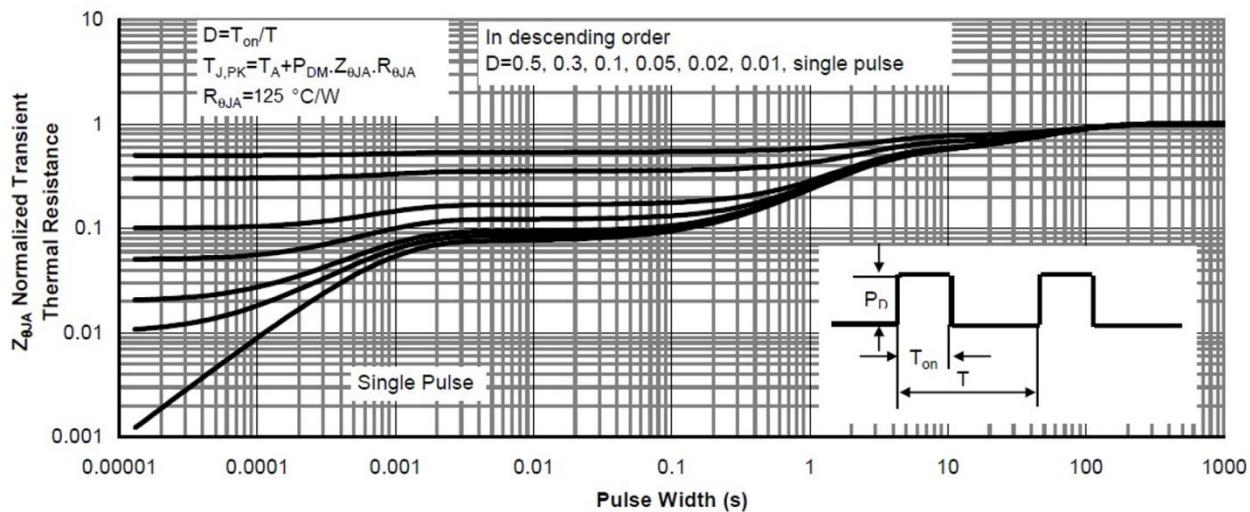
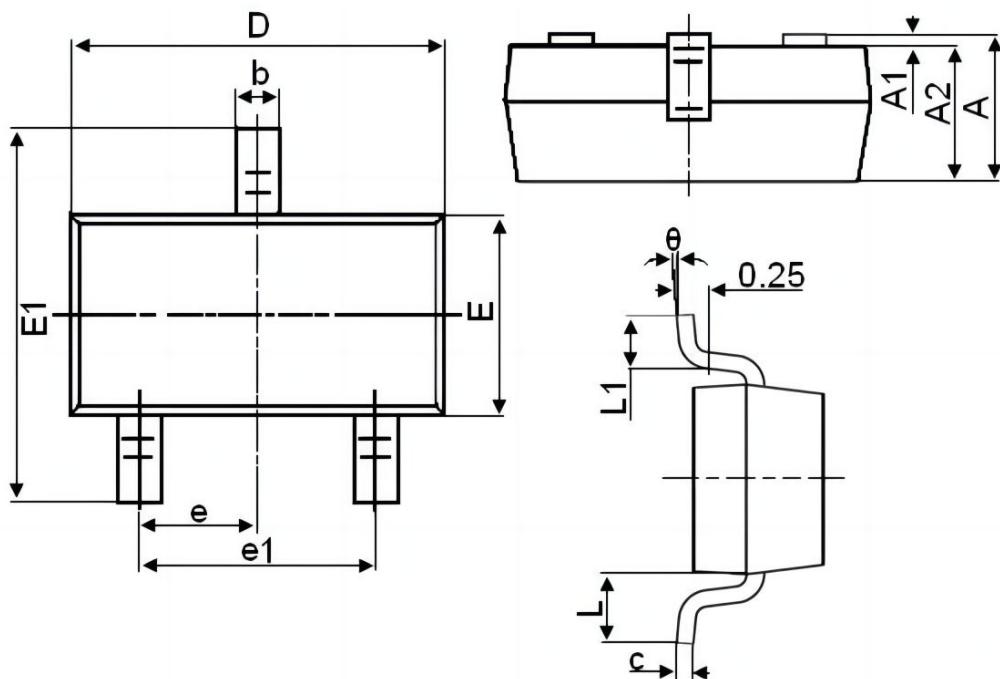


Figure 9. Normalized Maximum Transient Thermal Impedance

## SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.200	0.003	0.008
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 REF.		0.037 REF.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°